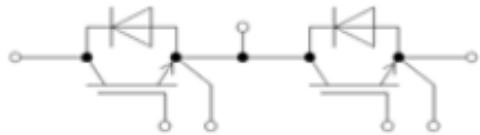


**技术信息 / Technical Information**

IGBT-模块  
IGBT-modules

**LMIBH100-12**

94mm×34mm 中压 IGBT 模块  
94mm×34mm medium voltage IGBT modules



半桥 IGBT / half bridge IGBT



$V_{CES}=1200V$   $I_C=100A$

**特性**

采用 SPT<sup>+</sup>技术 IGBT 芯片，超低开关损耗  
低  $V_{CEsat}$   
低驱动功率  
采用氧化铝陶瓷基板，模块热阻较低  
工业标准化封装，安装方便

**Features**

SPT+chip-set for ultra low switching losses  
Low  $V_{CE sat}$   
Low driving power  
 $Al_2O_3$  substrates for low thermal resistance  
Industry standard package assembling easily

**典型应用**

中压变流器/逆变器  
电焊机变频器  
中低压 UPS 系统

**Typical Application**

Medium voltage converters / inverters  
Transducer for electric welding machine  
Medium and low voltage UPS system



静电敏感设备 (ESD) ,请勿直接用手触摸辅助电极。  
This is an Electro-Static Discharge device, please don't touch the auxiliary terminal by hand.

撰写: JJ

版本: REV1.0

**Maximum Rated Values / 最大额定值**

Parameter/参数	Symbol/符号	Conditions/条件	Min/最小	Max/最大	Unit/单位
Collector-emitter voltage 集电极-发射极电压	$V_{CES}$	$V_{GE}=0V, T_{vj} \geq 25^\circ C$		1200	V
DC collector current 集电极电流	$I_C$	$T_C=85^\circ C$		100	A
Peak collector current 集电极峰值电流	$I_{CM}$	$t_p=1ms, T_C=80^\circ C$		200	A
Gate emitter voltage 栅极发射极电压	$V_{GE}$		-20	20	V
Total power dissipation 总功率损耗	$P_{tot}$	$T_C=25^\circ C$ , per switch(IGBT)		515	W
DC forward current 直流正向电流	$I_F$			100	A
Peak forward current 峰值正向电流	$I_{FPM}$	$t_p=1ms$		200	A
IGBT short circuit SOA IGBT 短路安全工作区	$t_{psc}$	$V_{CC}=600V, V_{CEM\ CHIP} \leq 1200V,$ $V_{GE} \leq 15V, T_{vj} \leq 125^\circ C$		10	us
Isolation voltage 绝缘电压	$V_{isol}$	1 min, $f=50Hz$		2500	V
Junction temperature 结温	$T_{vj}$			175	°C
Junction operating temperature 工作结温	$T_{vj(op)}$		-50	150	°C
Case temperature 壳温	$T_c$		-50	150	°C
Storage temperature 储存温度	$T_{stg}$		-50	125	°C
Mounting torques 安装力矩	$M_s$	Base-heatsink, M6 screws 基板-散热器, M6 螺丝	3	6	Nm
	$M_{t1}$	Main terminals, M6 screws 主端子, M6 螺丝	2.5	5	

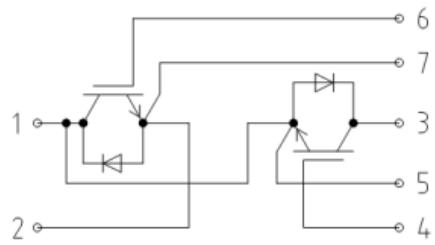
**IGBT characteristic values / IGBT 特征值**

Parameter/参数	Symbol/符号	Conditions/条件	Min/最小	Type/典型	Max/最大	Unit/单位
Collector-emitter breakdown voltage 集电极-发射极阻断电压	$V_{(BR)CES}$	$V_{GE}=0V, I_C=3mA, T_{vj}\geq 25^\circ C$	1200			V
Collector emitter saturation voltage 集电极-发射极饱和电压	$V_{CE\ sat}$	$I_C=100A, V_{GE}=15V$	$T_{vj}=25^\circ C$		1.9	2.4
			$T_{vj}=125^\circ C$		2.0	2.6
Collector cut off current 集电极截至电流	$I_{CES}$	$V_{CE}=1200V, V_{GE}=0V$	$T_{vj}=25^\circ C$		3	mA
			$T_{vj}=125^\circ C$		30	
Gate leakage current 栅极漏电流	$I_{GES}$	$V_{CE}=0V, V_{GE}=\pm 20V, T_{vj}=125^\circ C$	-500		500	nA
Gate-emitter threshold voltage 栅极-发射极阈值电压	$V_{GE(th)}$	$I_C=16mA, V_{CE}=V_{GE}, T_{vj}=25^\circ C$	5.2		7.2	V
Gate charge 栅极电荷	$Q_g$	$I_C=100A, V_{CE}=600V, V_{GE}=-15V \dots +15V$		0.94		uC
Turn on delay time 开通延迟时间	$t_{d(on)}$	$V_{CC}=600V, I_C=100A, V_{GE}=\pm 15V, R_G=3.9\Omega, L_s=200nH, inductive load$	$T_{vj}=25^\circ C$	170		ns
Rise time 上升时间	$t_r$		$T_{vj}=125^\circ C$	200		
Turn off delay time 关断延迟时间	$t_{d(off)}$		$T_{vj}=25^\circ C$	30		
Fall time 下降时间	$T_f$		$T_{vj}=125^\circ C$	50		
Turn on switching loss energy 开通能量损耗	$E_{on}$		$T_{vj}=25^\circ C$	280		
Turn off switching loss energy 关断能量损耗	$E_{off}$		$T_{vj}=125^\circ C$	300		
Turn on switching loss energy 开通能量损耗	$E_{on}$		$T_{vj}=25^\circ C$	280		mJ
Turn off switching loss energy 关断能量损耗	$E_{off}$		$T_{vj}=125^\circ C$	300		
Short circuit current 短路电流	$I_{sc}$	$V_{CC}=900V, V_{GE}=15V, L_s=200nH, inductive load$		400		A

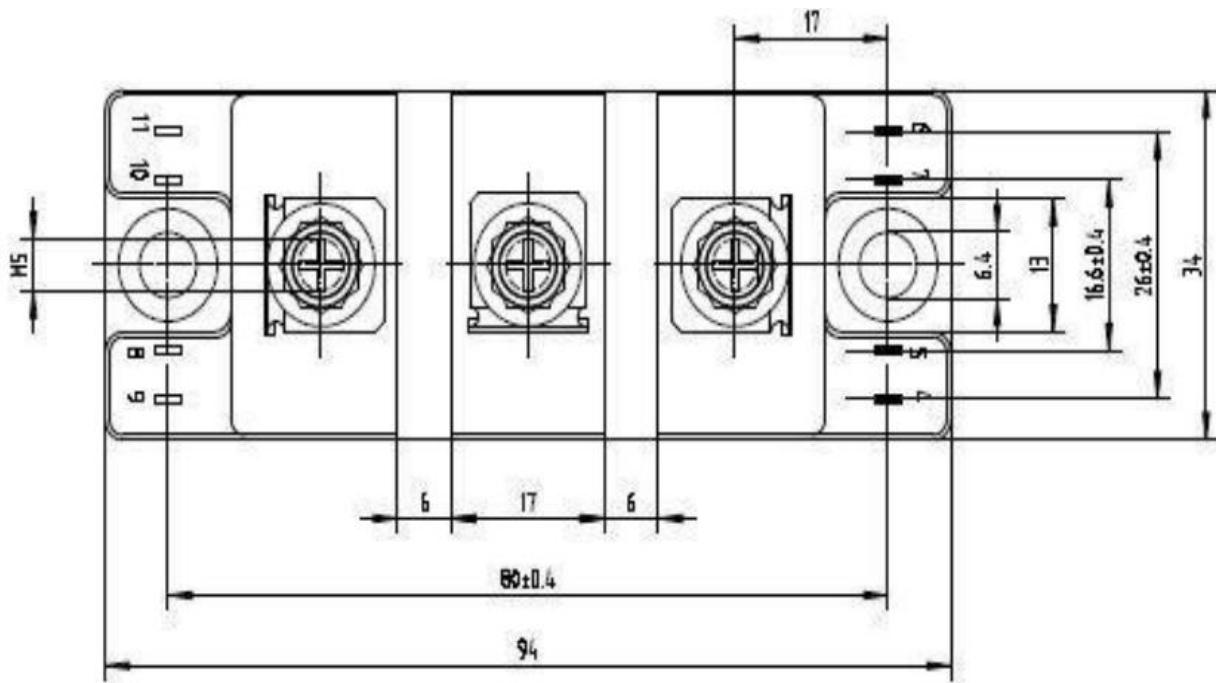
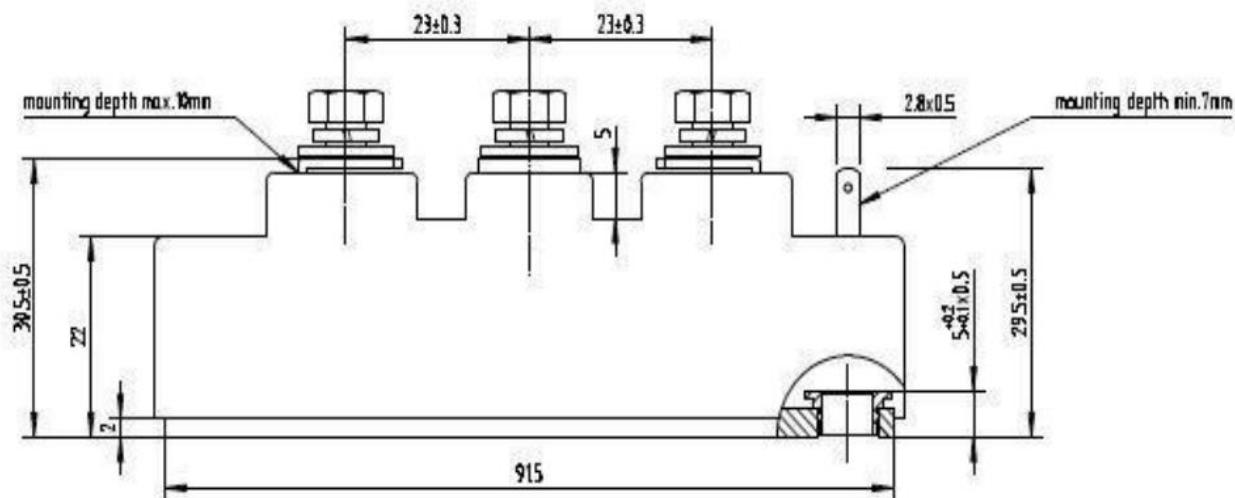
**Diode characteristic values / 二极管特征值**

Parameter/参数	Symbol/符号	Conditions/条件	Min/最小	Type/典型	Max/最大	Unit/单位
Forward voltage 正向电压	$V_F$	$I_F=100A,$	$T_{vj}=25^\circ C$		1.8	2.4
			$T_{vj}=125^\circ C$		1.9	2.5
Reverse recovery current 反向恢复电流	$I_{rr}$	$V_{CC}=600V,$ $I_C=100A,$ $V_{GE}=\pm 15V,$ $R_G=3.9\Omega,$ $L_s=200nH,$ inductive load	$T_{vj}=25^\circ C$		110	A
			$T_{vj}=125^\circ C$		120	
Recovered charge 恢复电荷	$Q_{rr}$		$T_{vj}=25^\circ C$		14	uC
			$T_{vj}=125^\circ C$		16	
Reverse recovery time 反向恢复时间	$t_{rr}$		$T_{vj}=25^\circ C$		270	ns
			$T_{vj}=125^\circ C$		300	
Reverse recovery energy 反向恢复能量	$E_{rec}$		$T_{vj}=25^\circ C$		8	mJ
			$T_{vj}=125^\circ C$		10	

### Electrical configuration / 电气结构



### Outline drawing / 外形尺寸



Note: All dimensions are shown in millimeters

注意：所有尺寸皆为毫米

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